

List of Current Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 1 - 7 (Cancelled).

8. (New) A circuit board with at least one connection bore for receiving a connection wire or pin of an electronic component of a predetermined pin or wire cross section, the improvement wherein:

said at least one connection bore is formed from at least two neighboring and partially, mutually overlapping bores, said two bores are placed relative to one another in such a manner that a narrowing is formed in the interior of said at least one connection bore and the narrowing controllably, securely seizes the connection wire or pin said at least one connection bore.

9. (New) The circuit board as claimed in claim 8, wherein:

by suitable choice of the separation of said bores mutually overlapping relative to one another and by taking into consideration the pin or wire cross section, the seizing action of the narrowing of said at least one connection bore is adjustable.

10. (New) The circuit board as claimed in claim 8, wherein:

said overlapping bores have different diameters.

11. (New) The circuit board as claimed in claim 8, wherein:

said overlapping in bores are drilled from the same side of the circuit board.

12. (New) The circuit board as claimed in claim 8, wherein:

the actual number of said overlapping bores forming said at least one connection bore is selected as a function of the cross sectional shape of said connection pin or wire to be received.

13. (New) The circuit board as claimed in claim 8, wherein:
said at least one connection bore formed from said overlapping bores is
over-drilled by a central, nontraversing, blind-hole bore.

14. (New) The circuit board as claimed in claim 8, wherein:
said at least one connection bore is metallized.